

Date: 05/03/16 PCN: 370

PRODUCT CHANGE NOTICE

Dear Valued Lantronix Customer,

The purpose of this communication is to inform you of an immediate change to the XPort Pro family of products. This change is part of our effort and commitment to continuous improvement of our products and processes.

Change Type

Hardware

Products Affected

Part Number	Description	Old Revision	New Revision
XPP1003000-02R	XPort Pro Device Networking Module, Linux OS, 16MB SRAM, AES Encryption, Extended Temperature, RoHS, Bulk	B13	B14
XPP100300S-02R	XPort Pro Device Networking Module, Linux OS, 16MB SRAM, AES Encryption, Extended Temperature, RoHS, Sample	B13	B14
XPP1004000-02R	XPort Pro Lx6 Device Networking Module, Linux OS, IPv6 Enabled, 16MB SRAM, AES Encryption, Extended Temperature,, RoHS, Bulk	D15	D16
XPP100400S-02R	XPort Pro Lx6 Device Networking Module, Linux OS, IPv6 Enabled, 16MB SRAM, AES Encryption, Extended Temperature,, RoHS, Sample	D15	D16

Description and Extent of Change

- 1. Thermal grease material changed from acrylic-based to resin-based compound
- 2. Connector changed from Panasonic to Molex
- 3. Enlarged PCB microvias

Reason for Change

- 1. Appearance and performance enhancement
- 2. Component EOL
- 3. Enhance product robustness

Effect of Change on Fit, Form, or Function

There is no impact to product fit, form, and function.

Effective Date of Change

Affected products with the above changes will begin shipping from the factory immediately.

If you have any questions, please contact your sales representative or Lantronix Technical Support at (800) 422-7044 or (949) 453-7198.

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